

ETR05087-001a

HiSAT-COT® Control, 1A Synchronous Step-Down DC/DC Converters

☆Green Operation compatible

■GENERAL DESCRIPTION

The XC9285/XC9286 series are 1.0A synchronous step-down DC/DC converters with a built-in P-channel driver FET and N-channel driver FET.

The Output voltage is internally set in a range from 0.8V to 3.6V increments of 0.05V. Only an inductor and two capacitors were connected externally.

HiSAT-COT is a proprietary high-speed transient response technology for DC/DC converter which was minimized output voltage during load fluctuations. It is Ideal for the applications with large instantaneous load fluctuations such as FPGAs and equipment that requires stable output voltage. Two types of package SOT-25, USP-6C are available.

(*) HiSAT-COT is a proprietary high-speed transient response technology for DC/DC converter which was developed by Torex. It is Ideal for the LSI's that require high precision and high stability power supply voltage.

APPLICATIONS

- Communication equipment / modules (Bluetooth/Wi-Fi/GPS etc.)
- Power supply for MCU/FPGA/ASIC (POL power supply)
- Smart phones/Mobile phones
- DSC/Camcorder
- Portable game consoles
- Wearable devices
- Active cable/Active optical cable

■FEATURES

Input Voltage Range : 2.5V ~ 5.5V

Output Voltage Range : $0.8V \sim 3.6V (\pm 2.0\%)$

Output Current : 1.0A
Oscillation Frequency : 1.2MHz
92%

Efficiency : (V_{IN}=3.8V,V_{OUT}=1.8V,I_{OUT}=200mA)

Quiescent Current : 15µA

Control Methods : HiSAT-COT Control

PWM Control (XC9285) PWM/PFM Auto (XC9286)

Protection Functions : Thermal Shutdown

Current Limit

Short Protection (B Type)

Functions : Soft-Start

UVLO

C_L Discharge (B Type)

Input/Output Capacitor : Ceramic Capacitor

Operating Ambient Temperature : -40° C ~ 105° C

Packages : USP-6C (1.8x2.0xh0.6mm)

SOT-25 (2.8x2.9xh1.3mm)

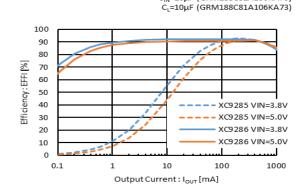
L=2.2µH (DFE252012F-2R2M) =10uF (GRM188C81A106KA73)

Environmentally Friendly : EU RoHS Compliant, Pb Free

■TYPICAL APPLICATION CIRCUIT

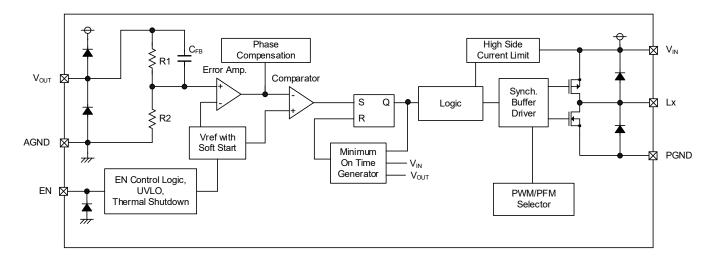
■TYPICAL PERFORMANCE CHARACTERISTICS

 $V_{OUT(T)}$ =1.8V, f_{OSC} =1.2MHz



■BLOCK DIAGRAM

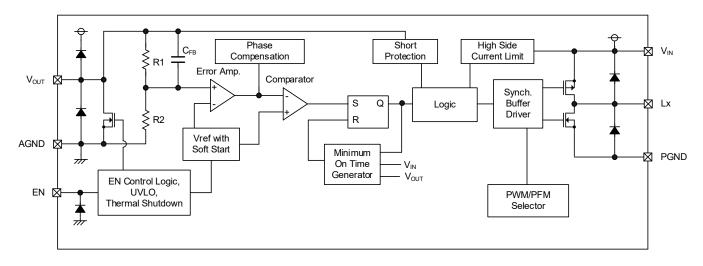
1) A Type



"PWM/PFM Selector" in the XC9285 series is fixed to PWM control.
 "PWM/PFM Selector" in the XC9286 series is fixed to PWM/PFM automatic switching control.
 Diodes inside the circuit are ESD protection diodes and parasitic diodes.

Regarding SOT-25, PGND and AGND are shorted inside the IC and the pin name is GND.

2) B Type



"PWM/PFM Selector" in the XC9285 series is fixed to PWM control.
 "PWM/PFM Selector" in the XC9286 series is fixed to PWM/PFM automatic switching control.
 Diodes inside the circuit are ESD protection diodes and parasitic diodes.

Regarding SOT-25, PGND and AGND are shorted inside the IC and the pin name is GND.

■PRODUCT CLASSIFICATION

Ordering Information

 $\underline{\text{XC9285} \textcircled{1} \textcircled{2} \textcircled{3} \textcircled{4} \textcircled{5} \textcircled{6} - \textcircled{7}} : \text{PWM control}$

 $\underline{\text{XC9286}\underline{\,\,}\underline{\,\,}2\underline{\,\,}3\underline{\,\,}4\underline{\,\,}5\underline{\,\,}6\underline{\,\,}\underline{\,\,}7\underline{\,\,}}$: PWM/PFM Automatic switching control

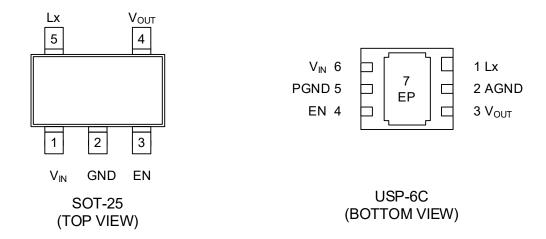
DESIGNATOR	ITEM	SYMBOL	DESCRIPTION
(1)	Tuno	А	Refer to Selection Guide
U	Туре	В	Relei to Selection Guide
23	Output Voltage	08 ~ 36	Output voltage e.g. 1.2V → ②=1, ③=2 1.25V → ②=1, ③=C 0.05V increments : 0.05=A, 0.15=B, 0.25=C, 0.35=D, 0.45=E, 0.55=F, 0.65=H, 0.75=K, 0.85=L, 0.95=M
4	Oscillation Frequency	С	1.2MHz
(5)(6)-(7) (*1)	Pookogoo (Ordor Unit)	MR-G	SOT-25 (3,000pcs/Reel)
5 6-7 (*1)	Packages (Order Unit)	ER-G	USP-6C (3,000pcs/Reel)

^(*1) The "-G" suffix denotes Halogen and Antimony free as well as being fully EU RoHS compliant.

Selection Guide

- COLOCULOTI CUIGO				
FUNCTION	A TYPE	B TYPE		
Enable	Y	es		
UVLO	Y	es		
Soft-Start Time	Fix	red		
C∟ Discharge	No	Yes		
Current Limit	V	Yes		
(Automatic Recovery)	11	55		
Short Protection	No	Yes		
(Latch Protection)	NO	1 65		
Thermal Shutdown	Y	es		

■PIN CONFIGURATION



^{*} USP-6C: Be sure to short the AGND pin (Pin 2) and PGND pin (Pin 5) when using.

■PIN ASSIGNMENT

PIN NI	UMBER	PIN NAME	FUNCTIONS
SOT-25	USP-6C	PIN NAIVIE	FUNCTIONS
1	6	VIN	Power Input
2	-	GND	Ground
-	5	PGND	Power Ground
-	2	AGND	Analog Ground
3	4	EN	Enable
4	3	V _{оит}	Output Voltage Monitor
5	1	Lx	Switching
-	7	EP	Exposed thermal pad. The Exposed pad must be connected to PGND, AGND (Pin2,5)

■FUNCTION TABLE

PIN NAME	SIGNAL	STATUS	
	L	Stand-by	
EN	Н	Active	
	OPEN	Undefined State (*1)	

^(*1) Please do not leave the EN pin open.

■ABSOLUTE MAXIMUM RATINGS

Ta=25°C

PARAMETER		SYMBOL	RATINGS	UNITS
V _{IN} Pin Vo	Itage	Vin	-0.3 ~ 6.2	V
Lx Pin Vol	tage	V _{Lx}	-0.3 ~ V _{IN} + 0.3 or 6.2 ^(*1)	V
V _{OUT} Pin Voltage		Vouт	-0.3 ~ V _{IN} + 0.3 or 4.0 ^(*2)	V
EN Pin Vo	EN Pin Voltage		-0.3 ~ 6.2	V
Power Dissipation	SOT-25	760 (JESD51-7 board	760 (JESD51-7 board) ^(*3)	\^/
(Ta=25°C)	USP-6C	Pd	1250 (JESD51-7 board) (*3)	mW
Junction Temperature		Tj	-40 ~ 125	°C
Storage Temp	perature	Tstg	-55 ~ 125	°C

All voltages are described based on the AGND and PGND(GND) pin.

■ RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS
Input Voltage	VIN	2.5	-	5.5	V
EN Pin Voltage	V _{EN}	0.0	-	5.5	V
Output Current	Іоит	-	-	1.0	Α
Operating Ambient Temperature	Topr	-40	-	105	င
Input Capacitor (Effective Value)(*1)	Cin	3.8	10	1000 (*2)	μF
Output Capacitor (Effective Value)(*1)	CL	5.8	10	470 (*3)	μF
Inductor	L	2.2 x 0.7	2.2	2.2 x 1.3	μH

All voltages are described based on the AGND and PGND(GND) pin.

^(*1) The maximum value should be either V_{IN}+0.3V or 6.2V in the lowest voltage.

 $^{^{(*2)}}$ The maximum value should be either V_{IN} +0.3V or 4.0V in the lowest voltage.

^(*3) The power dissipation figure shown is PCB mounted and is for reference only. Please refer to PACKAGE INFORMATION for the mounting condition.

^(*1) Some ceramic capacitors have an effective capacitance that is significantly lower than the nominal value due to the applied DC bias and ambient temperature. For the input / output capacitance of this IC, use an appropriate ceramic capacitor according to the DC bias usage conditions (ambient temperature, input / output voltage) so that the effective capacitance value is equal to or higher than the recommended component.

^(*2) If using a large-capacity capacitor such as an electrolytic capacitor or tantalum capacitor as the input capacitance, place a low ESR ceramic capacitor in parallel. If a ceramic capacitor is not placed, high-frequency voltage fluctuations will increase and the IC may malfunction.

^(*3) If using a large-capacity capacitor as the output capacitance of a B type (with short protection function), the output voltage may not rise during the soft-start time and the short protection function will operate after the soft-start time, causing the IC to latch and stop.

■ELECTRICAL CHARACTERISTICS

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS		MIN.	TYP.	MAX.	UNITS	CIRCUIT
TAVAMETER	STWIDOL			IVIII N.	111.	IVIAA.	ONTO	CIRCOIT
	.,	$V_{\text{IN}} = V_{\text{OUT}(T)} + 2.0V(V_{\text{OUT}(T)} \le 3.5V)$ or					.,	
Output Voltage	V_{OUT}	5.5V(V _{OUT(T)} >3.5V), V _{OUT} = <e-3>-</e-3>		<e-1></e-1>	<e-2></e-2>	<e-3></e-3>	V	3
		V _{OUT} Voltage When Lx pin is V _{IN}	or oscillations					
Operating Voltage Range	V _{IN}			2.5	-	5.5	V	1
Maximum Output Current	I _{OUTMAX}	When connected to external compo	nents,	1000	-	-	mA	1
		V_{IN} = <c-1> V_{IN}=2.5V to 1.2V, V_{OUT}=0.6V,</c-1>						
UVLO Detect Voltage	V_{UVLOD}	V _{IN} Voltage when Lx pin changes "H	" to "" "" lovol"	1.35	1.95	-	V	3
		V_{IN} = 1.2V to 2.5V, V_{OUT} =0.6V,	I to L level					
UVLO Release Voltage	V_{UVLOR}	V _{IN} Voltage when Lx pin changes "L	" to ""H"" level"	-	2.00	2.48	V	3
Quiescent Current		VIN VOILAGE WHEN EX PIN CHANGES E	to 11 level					
(XC9286)	lq	$V_{OUT}=V_{OUT(T)}\times 1.1$		-	15	25	μΑ	2
Quiescent Current								
(XC9285)	lq	$V_{OUT}=V_{OUT(T)}\times 1.1$		-	250	455	μA	2
Stand-by Current	I _{STB}	V _{EN} =0V		-	0.0	1.0	μA	2
	_	When connected to external con	nponents,				·	
ON time	t _{ON}	V _{IN} =V _{EN} = <c-1>, I_{OUT}=1mA</c-1>		<e-5></e-5>	<e-6></e-6>	<e-7></e-7>	ns	1
Thermal shutdown	T _{TSD}			-	150	-	°C	1
Thermal shutdown hysteresis	T _{HYS}		-	30	-	°C	1	
Lx SW"H"ON Resistance	R _{LXH}	V _{OUT} =0.6V, I _{LX} =100mA		-	0.24	0.44	Ω	4
Lx SW"L"ON Resistance (*1)	R _{LXL}	V_{IN} =3.6V, V_{OUT} = $V_{OUT(T)}$ ×1.1, I_{LX} =1	100mA	-	0.16	0.34	Ω	4
Lx SW"H" Leakage Current	I _{LeakH}	V_{IN} =5.5V, V_{EN} =0V, V_{OUT} =0V, V_{LX}	=0V	-	0.0	1.0	μΑ	5
Lx SW"L" Leakage Current	I _{leakL}	V_{IN} =5.5V, V_{EN} =0V, V_{OUT} =0V, V_{LX}	=5.5V	-	0.0	1.0	μΑ	5
Current Limit (*2)	I _{LIMH}	V_{OUT} =0.6V I_{Lx} until Lx pin oscillat	es	1.3 (*1)	1.5	2.5 (*1)	Α	6
Output Voltage	ΔV_{OUT} /							
Temperature	(V _{OUT} •	I _{OUT} =30mA, -40°C≦Topr≦105°C		-	±100	-	ppm/°C	1
Characteristics	ΔTopr)		T					
		V _{OUT} =0.6V, Applied voltage to	Ta=25℃					
EN "H" Voltage	V_{ENH}	V _{EN} , Voltage changes Lx to "H"	Ta=-40~105°C(*1)	1.4	-	5.5	V	3
		level V _{OUT} =0.6V, Applied voltage to						
EN "L" Voltage	V_{ENL}	V _{EN} , Voltage changes Lx to "L"	Ta=25°C	GND ^(*3)		0.3	V	3
LIV L Voltage	V ENL	level	Ta=-40~105°C ^(*1)	GIND	-	0.5	v	3
EN "H" Current	I _{ENH}	V _{IN} =5.5V, V _{EN} =5.5V, V _{OUT} =0V		_	0.0	0.1	μA	5
EN "L" Current	I _{ENL}	V _{IN} =5.5V, V _{EN} =5.5V, V _{OUT} =0V V _{IN} =5.5V, V _{EN} =0V, V _{OUT} =0V		_	0.0	0.1	μA	5
EIV E Gairoin	IENL	$V_{EN}=0V \rightarrow 5.0V$, $V_{OUT}=V_{OUT(T)} \times 0.9$			0.0	0.1	μ, τ	•
Soft-Start Time	t _{ss}	After "H" is fed to EN, the time b		0.10	0.30	0.60	ms	3
551		generated at Lx pin.	-					
Short Protection	V_{SHORT}	Sweeping V _{OUT} , V _{OUT} voltage wh	ich Lx becomes	0.17	0.27	0.38	V	3
Voltage (B Type)	▼ SHORT	"L" level		0.17	0.21	0.00	, v	9
C _L Discharge	R _{DCHG}	V _{EN} =0V, V _{OUT} =4.0V		100	180	300	Ω	7
Resistance (B Type)	Done	2.1 - 7 - 661 - 11-1						Ú

V_{OUT(T)} : Nominal Voltage

Unless otherwise stated, V_{IN} =5.0V, V_{EN} =5.0V,

"H" level = V_{IN} - 1.2V ~ V_{IN} , "L" level = -0.1V ~ 0.1V

^(*1) Design value.

^(*2) Current limit denotes the level of detection at peak of Inductor current.

^(*3) AGND in the case of USP-6C.

■ ELECTRICAL CHARACTERISTICS (Continued)

SPFC Table

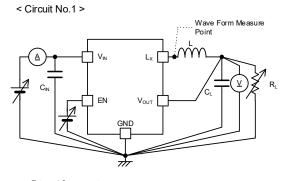
SPEC Table							
NOMINAL OUTPUT		V_{OUT}			to	ON	
VOLTAGE	<e-1></e-1>	<e-2></e-2>	<e-3></e-3>	<c-1></c-1>	<e-5></e-5>	<e-6></e-6>	<e-7></e-7>
V _{OUT(T)}	MIN.	TYP.	MAX.	V _{IN}	MIN.	TYP.	MAX.
0.80	0.780	0.800	0.820	2.50	183	267	350
0.85	0.830	0.850	0.870	2.50	197	283	370
0.90	0.880	0.900	0.920	2.50	210	300	390
0.95	0.930	0.950	0.970	2.50	223	317	410
1.00	0.980	1.000	1.020	2.50	237	333	430
1.05	1.029	1.050	1.071	2.50	268	350	433
1.10	1.078	1.100	1.122	2.50	282	367	452
1.15	1.127	1.150	1.173	2.50	296	383	471
1.20	1.176	1.200	1.224	2.50	310	400	490
1.25	1.225	1.250	1.275	2.50	324	417	509
1.30	1.274	1.300	1.326	2.50	338	433	528
1.35	1.323	1.350	1.377	2.50	353	450	548
1.40	1.372	1.400	1.428	2.50	367	467	567
1.45	1.421	1.450	1.479	2.50	381	483	586
1.50	1.470	1.500	1.530	2.50	395	500	605
1.55	1.519	1.550	1.581	2.58	395	500	605
1.60	1.568	1.600	1.632	2.67	395	500	605
1.65	1.617	1.650	1.683	2.75	395	500	605
1.70	1.666	1.700	1.734	2.83	395	500	605
1.75	1.715	1.750	1.785	2.92	395	500	605
1.80	1.764	1.800	1.836	3.00	395	500	605
1.85	1.813	1.850	1.887	3.08	395	500	605
1.90	1.862	1.900	1.938	3.17	395	500	605
1.95	1.911	1.950	1.989	3.25	395	500	605
2.00	1.960	2.000	2.040	3.33	395	500	605
2.05	2.009	2.050	2.091	3.42	395	500	605
2.10	2.058	2.100	2.142	3.50	395	500	605
2.15	2.107	2.150	2.193	3.58	395	500	605
2.20	2.156	2.200	2.244	3.67	395	500	605
2.25	2.205	2.250	2.295	3.75	395	500	605
2.30	2.254	2.300	2.346	3.83	395	500	605
2.35	2.303	2.350	2.397	3.92	395	500	605
2.40	2.352	2.400	2.448	4.00	395	500	605
2.45	2.401	2.450	2.499	4.08	395	500	605
2.50	2.450	2.500	2.550	4.17	395	500	605
2.55	2.499	2.550	2.601	4.25	395	500	605
2.60	2.548	2.600	2.652	4.33	395	500	605
2.65	2.597	2.650	2.703	4.42	395	500	605
2.70	2.646	2.700	2.754	4.50	395	500	605

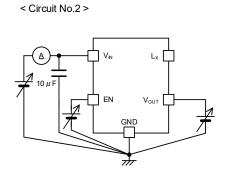
■ ELECTRICAL CHARACTERISTICS (Continued)

SPEC Table

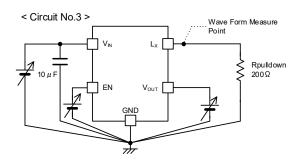
NOMINAL OUTPUT		V_{OUT}			to	DN	
VOLTAGE	<e-1></e-1>	<e-2></e-2>	<e-3></e-3>	<c-1></c-1>	<e-5></e-5>	<e-6></e-6>	<e-7></e-7>
$V_{\text{OUT(T)}}$	MIN.	TYP.	MAX.	V _{IN}	MIN.	TYP.	MAX.
2.75	2.695	2.750	2.805	4.58	395	500	605
2.80	2.744	2.800	2.856	4.67	395	500	605
2.85	2.793	2.850	2.907	4.75	395	500	605
2.90	2.842	2.900	2.958	4.83	395	500	605
2.95	2.891	2.950	3.009	4.92	395	500	605
3.00	2.940	3.000	3.060	5.00	395	500	605
3.05	2.989	3.050	3.111	5.08	395	500	605
3.10	3.038	3.100	3.162	5.17	395	500	605
3.15	3.087	3.150	3.213	5.25	395	500	605
3.20	3.136	3.200	3.264	5.33	395	500	605
3.25	3.185	3.250	3.315	5.42	395	500	605
3.30	3.234	3.300	3.366	5.50	395	500	605
3.35	3.283	3.350	3.417	5.50	401	508	614
3.40	3.332	3.400	3.468	5.50	408	515	622
3.45	3.381	3.450	3.519	5.50	414	523	631
3.50	3.430	3.500	3.570	5.50	421	530	640
3.55	3.479	3.550	3.621	5.50	427	538	649
3.60	3.528	3.600	3.672	5.50	434	545	657

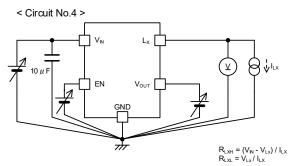
■TEST CIRCUITS

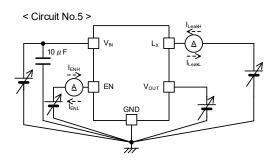


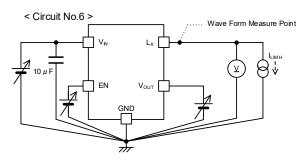


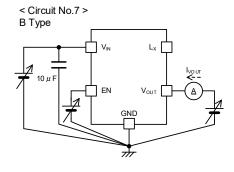
$$\begin{split} &\text{External Components} \\ &f_{\text{OSC}} = 1.2 \text{MHz} \\ &L \quad : 2.2 \, \mu \, \text{H} \\ &C_{\text{N}} \quad : 10 \, \mu \, \text{F(ceramic)} \\ &C_{L} \quad : 10 \, \mu \, \text{F(ceramic)} \end{split}$$



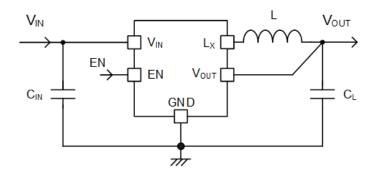








■TYPICAL APPLICATION CIRCUIT



[Typical Examples]

	MANUFACTURER	ANUFACTURER PRODUCT NUMBER		SIZE(L×W×T)
_	Murata	DFE252012F-2R2M=P2	2.2µH	2.5 x 2.0 x 1.2mm
L	Coilcraft	XGL3530-222MEC	2.2µH	3.5 x 3.2 x 3.0mm
C _{IN} (*1,2)	Murata	GRM188C81A106KA73D	10μF/10V	1.6 x 0.8 x 1.0mm
C _L (*1,3)	Murata	GRM188C81A106KA73D	10µF/10V	1.6 x 0.8 x 1.0mm

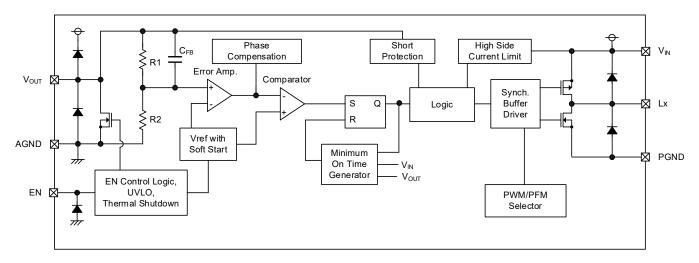
(*1) Some ceramic capacitors have an effective capacitance that is significantly lower than the nominal value due to the applied DC bias and ambient temperature. For the input / output capacitance of this IC, use an appropriate ceramic capacitor according to the DC bias usage conditions (ambient temperature, input / output voltage) so that the effective capacitance value is equal to or higher than the recommended component.

(*2) If using a large-capacity capacitor such as an electrolytic capacitor or tantalum capacitor as the input capacitance, place a low ESR ceramic capacitor in parallel. If a ceramic capacitor is not placed, high-frequency voltage fluctuations will increase and the IC may malfunction.

(*3) If using a large-capacity capacitor as the output capacitance of a B type (with short protection function), the output voltage may not rise during the soft-start time and the short protection function will operate after the soft-start time, causing the IC to latch and stop.

■OPERATIONAL EXPLANATION

This IC consists of a reference voltage source, error amplifier, comparator, phase compensation, on time generation circuit, current limiter circuit, UVLO circuit and so on.



BLOCK DIAGRAM (B Type)

The control method is HiSAT-COT (High Speed circuit Architecture for Transient with Constant On Time), which features the On time control method and the fast transient response with low ripple voltage.

<Nomal operation>

In HiSAT-COT control, ON time (ton) dependent on input voltage and output voltage is generated and Pch driver FET. Is turned on

The on-time is set as follows during light loads.

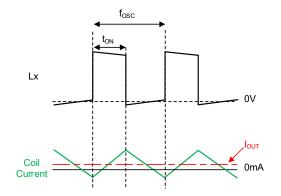
$$t_{ON} = (V_{OUT} / V_{IN}) \times 833 ns$$

The off time (toff) is controlled by comparing the output voltage and the reference voltage with the error amplifier and the comparator. Specifically, the reference voltage and a voltage which is obtained by dividing the output voltage with R1 and R2 are compared with using the error amplifier, apply phase compensation to the output of the error amplifier, and send it to the comparator. In the comparator, the output of the error amplifier is compared with the reference voltage, and when it falls below the reference voltage, the SR latch is set and it becomes the ON period again.

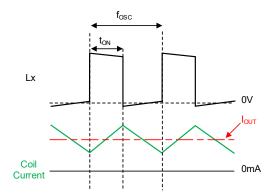
PWM control

The XC9285 series (PWM control) operates in continuous conduction mode and operates at a stable oscillation frequency regardless of the load. The oscillation frequency can be obtained by the following equation.

$$f_{OSC} = (V_{OUT} / V_{IN}) \times (1 / t_{ON})$$



XC9285 series: Example of light load operation

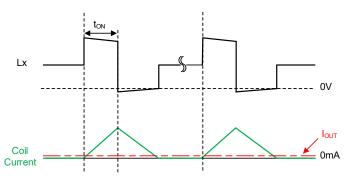


XC9285 series: Example of heavy load operation

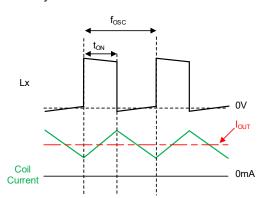
PWM/PFM automatic switching control

The XC9286 series (PWM/PFM automatic switching control) lowers the oscillation frequency at light load by operating in discontinuous conduction mode at light load.

As the output current increases, the switching frequency increases proportionally. By this operation, it is possible to reduce switching loss at light load and achieve high efficiency from light load to heavy load.



XC9286 series : Example of light load operation



XC9286 series: Example of heavy load operation

<100% Duty cycle mode>

In conditions where the input-output voltage difference is small or transient response, the Pch driver FET might keep on turning on and the 100% duty cycle mode might be set.

The 100% duty cycle mode achieves highspeed response and output voltage stability under the condition where input-output voltage difference is small.

<EN function>

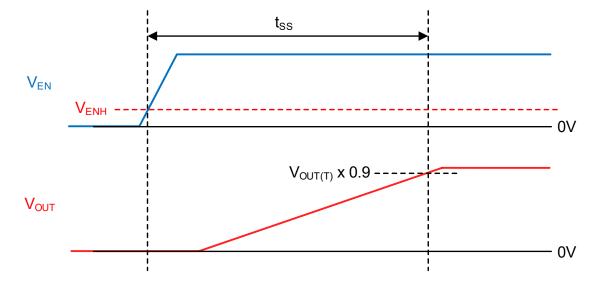
When "H" voltage (V_{ENH}) is fed to the EN pin, normal operation starts after raising the output voltage with the soft-start function. When the "L" voltage (V_{ENL}) is fed to the EN pin, it enters the stand-by state and the current consumption is suppressed to I_{STB} (TYP. $0.0\mu A$).

Additionally, Pch driver FET and Nch driver FET are turned off.

<Start Mode / Soft-Start function>

It is a function to raise the output voltage gradually and suppress inrush current. After the "H" voltage (V_{ENH}) is fed to the EN pin, the reference voltage which is connected to the error amplifier increases linearly during the soft-start period. As a result, the output voltage increases in proportion to the increase of the reference voltage. This operation can prevent a large inrush current and smoothly raise the output voltage.

During the soft-start function, the short protection function of B type does not operate. Also, even with PWM control, reverse inductor current is prohibited.



<Current Limit / Short protection>

The current limit function monitors a current flowing through Pch driver FET in each switching cycle and when Pch driver current is more than ILIMH (TYP. 1.5A), an overcurrent detection state occurs.

When the overcurrent detection state occurs, the Pch driver FET is turned off. If the current flowing through Pch driver FET is less than I_{LIMH} in the next switching cycle, the overcurrent detection state is released.

If the overcurrent detection state continues or if there is a significant drop in the output voltage, the B type short circuit protection function will operate.

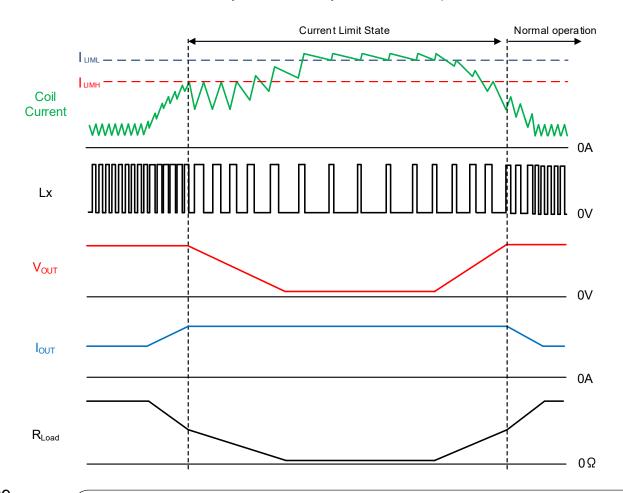
The detailed operation of each type at overcurrent is as follows.

Without Short Protection: A Type

- 1) When the current flowing through the Pch driver FET increases and reaches the current limit value I_{LIMH}=1.5A (TYP.), the current limit state is set and the Pch driver FET is forcibly turned off.
- 2) After the Pch driver FET is turned off, the Nch driver FET is turned on for a certain period of time, and the inductor current decreases. If there is an overload condition, the Pch driver FET will turn on again until inductor current reached the current limit value.
- 3) Further reducing the load resistance will drop output voltage.

When the output voltage drops, the inductor current does not decrease during the Nch Driver FET on period, and when the Pch driver turns on again, inductor current will increase more than the current limit value I_{LIMH}. When the inductor current flowing through the Nch driver FET increases, the Pch driver FET is prohibited to turn on until the current flowing through the Nch driver FET drops to I_{LIML}=2.0A (TYP.).

- 4) Repeat the operations 1) and 2) or 1) and 3) during the current limit state.
- 5) When the current limit state is released, the system automatically returns to normal operation.



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■ OPERATIONAL EXPLANATION (Continued)

<Current Limit / Short protection (Continued)>

With Short Protection: B Type

- 1) When the current flowing through the Pch driver FET increases and reaches the current limit value ILIMH=1.5A (TYP.), the current limit state is set and the Pch driver FET is forcibly turned off.
- 2) After the Pch driver FET is turned off, the Nch driver FET is turned on for a certain period of time, and the inductor current decreases. If there is an overload state, the Pch driver FET will turn on again until inductor current reached the current limit value.
- 3) Further reducing the load resistance will drop output voltage.

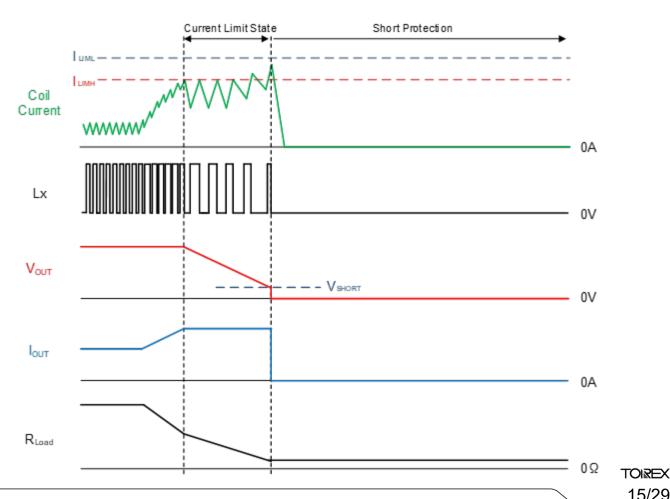
When the output voltage drops, the inductor current does not decrease during the Nch Driver FET on period, and when the Pch driver turns on again, inductor current will increase more than the current limit value ILIMH. When the inductor current flowing through the Nch driver FET increases, the Pch driver FET is prohibited to turn on until the current flowing through the Nch driver FET drops to I_{LIML}=2.0A (TYP.).

- 4) When the output voltage drops below short protection voltage V_{SHORT}=0.27V(TYP.) in an overload state, the short protection function operates and latched the Pch driver FET and Nch driver in the off state.
- Conditions for returning from latch stop.

There are two conditions for returning from latch stop due to short protection.

- Input "L" voltage to the EN pin to put it into stand-by state and then put IC into active state.
- After the input voltage is reduced to the UVLO detection state, a voltage higher than VUVLOR is applied to the input voltage and the input voltage is set to the normal state.

To recover from latch stop, the output voltage is raised with the soft-start function, and then normal operation is performed. If the overload state continues, the IC enters the current limit again. Then the current limit function and short protection function will operate.



<Thermal Shutdown function>

The Junction temperature is monitored to protect the IC from thermal damage.

When the junction temperature reached T_{TSD} (TYP. 150°C), thermal shutdown operates, the Pch driver FET and Nch driver FET will be turned off. At the same time, the output voltage decreases. When the junction temperature drops to the thermal shutdown release temperature T_{TSD} - T_{HYS} (TYP. 120°C) by stopping the current supply, the output voltage is raised with the soft-start function, and then normal operation is performed.

<UVLO function>

When the V_{IN} voltage becomes V_{UVLOD} (TYP. 1.95V) or less, the UVLO function operates to forcibly turn off the Pch driver FET to prevent erroneous pulse output due to operation instability of the internal circuit.

When the V_{IN} voltage becomes V_{UVLOR} (TYP. 2.0V) or more, the UVLO function is canceled. After the UVLO function is canceled, the output voltage rises with the soft-start function, and then the normal operation is performed.

Moreover, during the UVLO operation, the internal circuit is operating because stopping by UVLO is not same to a stand-by mode and just switching operation is stopped.

<C_L Discharge function>

B type uses an Nch FET and resistor connected to the V_{OUT} pin to rapidly discharge the charge on the output capacitor. In order to prevent malfunction of application due to charge remaining on the output capacitor (EN="L") during stand-by. It also operates in the UVLO detection state.

The output voltage during discharging can be calculated by the following equation.

 $V = V_{OUT} \times e^{-t/\tau}$ $t = \tau Ln (V_{OUT}/V)$

V : Output voltage during discharge

V_{OUT} : Output voltage t : Discharge time

C_L : Effective capacitance of Output capacitor

 R_{DCHG} : C_L auto-discharge resistance

 τ : $C_L \times R_{DCHG}$

■NOTE ON USE

- 1) For the phenomenon of temporal and transitional voltage decrease or voltage increase, the IC may be damaged or deteriorated if IC is used beyond the absolute MAX. specifications. Also, if used under out of the recommended operating range, the IC may not operate normally or may cause deterioration.
- 2) Spike noise and ripple voltage arise in a switching regulator as with a DC/DC converter. These are greatly influenced by external component selection, such as the inductor inductance, capacitance values, and board layout of external components. Once the design has been completed, verification with actual components should be done.
- 3) The DC/DC converter characteristics depend greatly on the externally connected components as well as on the characteristics of this IC, so refer to the specifications and standard circuit examples of each component when carefully considering which components to select. Especially for C_L capacitor, it is recommended to use an appropriate ceramic capacitor according to the DC bias usage conditions (ambient temperature, input / output voltage) so that the effective capacitance value is equal to or higher than the recommended component.
- 4) Due to propagation delay inside the product, the on time generated by the on time generation circuit is not the same as the on time that is the ratio of the input voltage to the output voltage.
- 5) The actual inductor current may at times exceed the current limit value (I_{LIMH}) due to propagation delays in the current limiting circuit.
- 6) Regarding PWM/PFM auto switching control method, it works with a discontinuous conduction mode at light loads, and in this case where the voltage difference between input voltage and output voltage is low, the inductor current may reverse when the load is light, and thus pulse skipping will not be possible and light load efficiency will worsen.
- 7) When the voltage difference between input voltage and output voltage is low, the load stability feature may deteriorate.
- 8) Torex places an importance on improving our products and their reliability. We request that users incorporate fail safe designs and post aging protection treatment when using Torex products in their systems.

■NOTE ON USE (Continued)

Instructions of pattern layouts

Especially noted in the pattern layout are as follows.

Please refer to the reference pattern layout on the next page.

- (a) Wire the large current line using thick, short connecting traces.
 - This makes it possible to reduce the wire impedance, which is expected to reduce noise and improve heat dissipation. If the wire impedance of the large current line is large, it may cause noise or the IC to not operate normally.
- (b) Place the input capacitance C_{IN}, output capacitance C_L, inductor L and IC which the large current flows on the same surface. If they are placed on both sides, a large current will flow through Via, which has high impedance, it may cause noise and the IC may not operate normally.
- (c) Please mount each external component as close to the IC as possible.

 Especially place the input capacitance C_{IN} near the IC and connect it with as low impedance as possible.

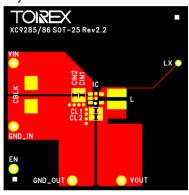
 If the input capacity C_{IN} and IC are too far apart, it may cause noise or the IC may not operate normally.

■NOTE ON USE (Continued)

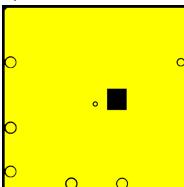
<Reference pattern layout>

SOT-25

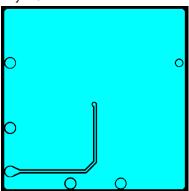
Layer 1



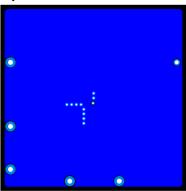
Layer 2



Layer 3

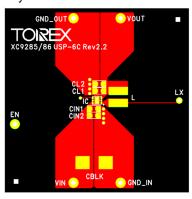


Layer 4

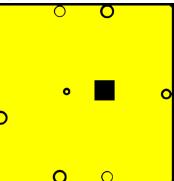


USP-6C

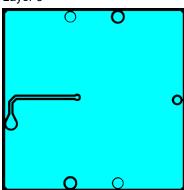
Layer 1



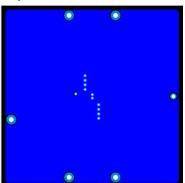
Layer 2



Layer 3



Layer 4

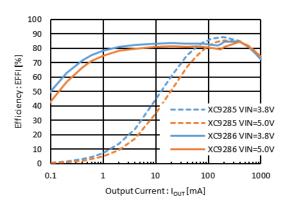


■TYPICAL PERFORMANCE CHARACTERISTICS

(1) Efficiency vs. Output Current

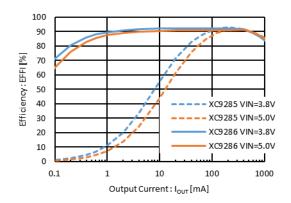


L=2.2μH (DFE252012F-2R2M) C_{IN}=10μF (GRM188C81A106KA73) C_L=10μF (GRM188C81A106KA73)



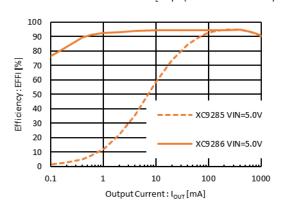
$V_{OUT(T)}$ =1.8V

L=2.2µH (DFE252012F-2R2M) C_{IN}=10µF (GRM188C81A106KA73) C_L=10µF (GRM188C81A106KA73)



$V_{OUT(T)}=3.3V$

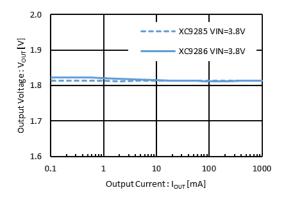
L=2.2µH (DFE252012F-2R2M) C_{IN}=10µF (GRM188C81A106KA73) C_I=10µF (GRM188C81A106KA73)



C_{IN}=10μ

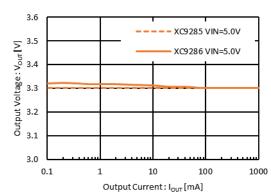
(2) Output Voltage vs. Output Current

$$V_{OUT(T)}=1.8V$$

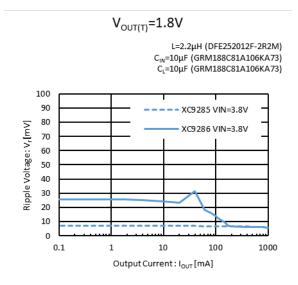


V_{OUT(T)}=3.3V

 $\begin{array}{c} L{=}2.2\mu H \; (DFE252012F{-}2R2M) \\ C_{IN}{=}10\mu F \; (GRM188C81A106KA73) \\ C_{L}{=}10\mu F \; (GRM188C81A106KA73) \end{array}$



(3) Output Voltage vs. Ripple Voltage



 $V_{OUT(T)}$ =3.3V $\begin{array}{l} \text{L=2.2}\mu\text{H (DFE252012F-2R2M)} \\ \text{C}_{\text{IN}}\text{=}10\mu\text{F (GRM188C81A106KA73)} \\ \text{C}_{\text{L}}\text{=}10\mu\text{F (GRM188C81A106KA73)} \end{array}$ 100 90 XC9285 VIN=5.0V 80 Ripple Voltage: V_r[mV] XC9286 VIN=5.0V 70 60 50 40 30 20 10 0 1000

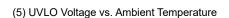
10

Output Current : I_{OUT} [mA]

100

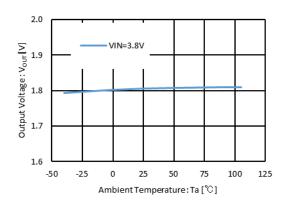
(4) Output Voltage vs. Ambient Temperature

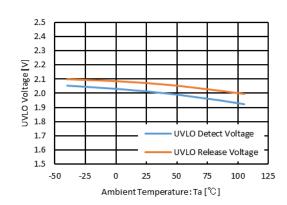
 $V_{OUT(T)}=1.8V$



1

0.1

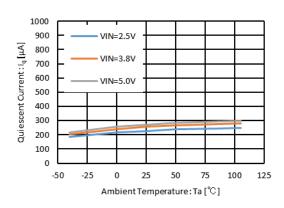


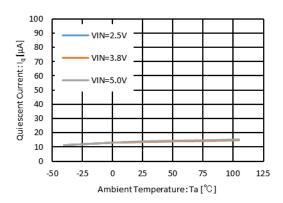


(6) Quiescent Current vs. Ambient Temperature

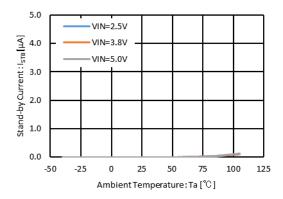
XC9285





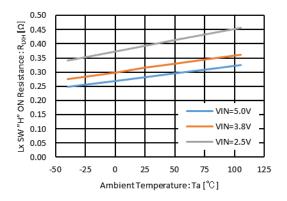


(7) Stand-by Current vs. Ambient Temperature

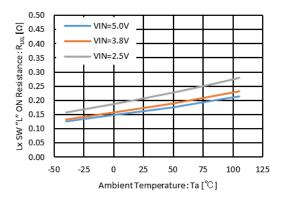


(8) Lx SW "H" ON Resistance vs. Ambient Temperature

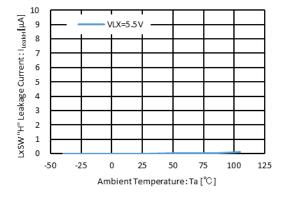
(9) Lx SW "L" ON Resistance vs. Ambient Temperature

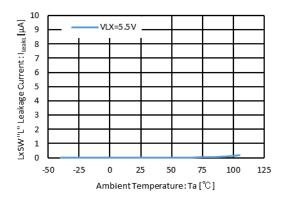


(11) Lx SW "H" Leakage Current vs. Ambient Temperature



(12) Lx SW "L" Leakage Current vs. Ambient Temperature

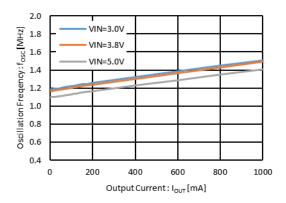




(13) Oscillation Frequency vs. Output Current (Continued)

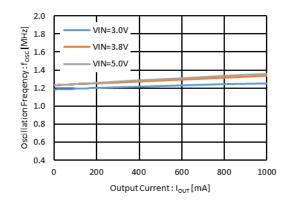
$XC9285, V_{OUT(T)} = 0.8V$

 $\begin{array}{l} L{=}2.2\mu H \; (DFE252012F{-}2R2M) \\ C_{IN}{=}10\mu F \; (GRM188C81A106KA73) \\ C_{L}{=}10\mu F \; (GRM188C81A106KA73) \end{array}$



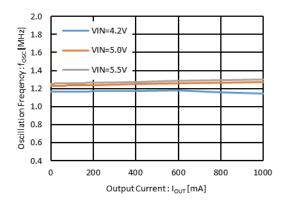
$XC9285, V_{OUT(T)}=1.8V$

 $\begin{array}{l} \text{L=2.2}\mu\text{H (DFE252012F-2R2M)} \\ \text{C}_{\text{IN}}\text{=}10\mu\text{F (GRM188C81A106KA73)} \\ \text{C}_{\text{L}}\text{=}10\mu\text{F (GRM188C81A106KA73)} \end{array}$



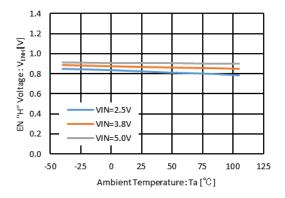
$XC9285, V_{OUT(T)} = 3.3V$

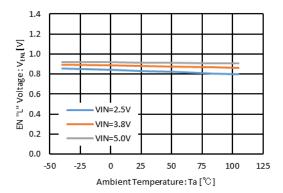
L=2.2μH (DFE252012F-2R2M) C_{IN}=10μF (GRM188C81A106KA73) C_L=10μF (GRM188C81A106KA73)



(14) EN "H" Voltage vs. Ambient Temperature

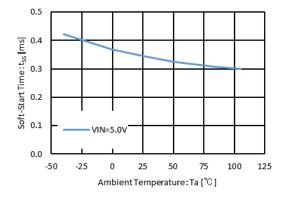
(15) EN "L" Voltage vs. Ambient Temperature

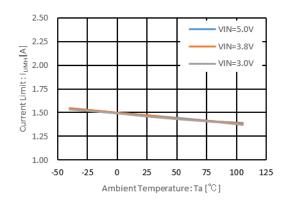




(16) Soft-Start Time vs. Ambient Temperature

(17) Current Limit vs. Ambient Temperature



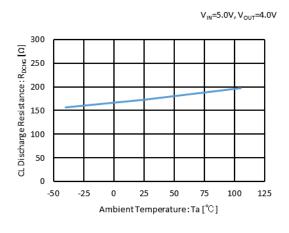


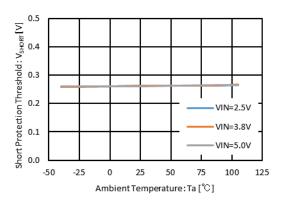
(19) C_L Discharge Resistance vs. Ambient Temperature

XC9285B/XC9286B

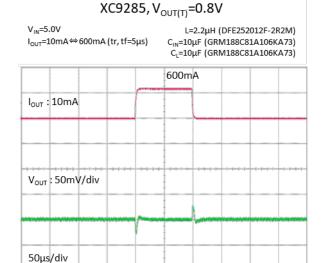
(20) Short Protection Threshold vs. Ambient Temperature

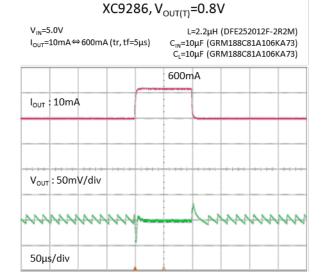
XC9285B/XC9286B

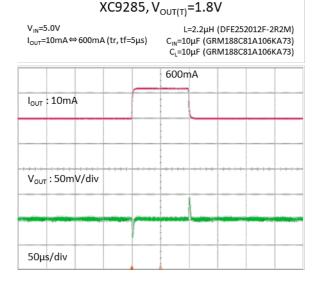


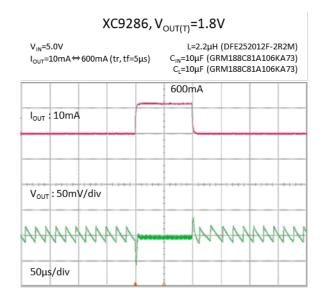


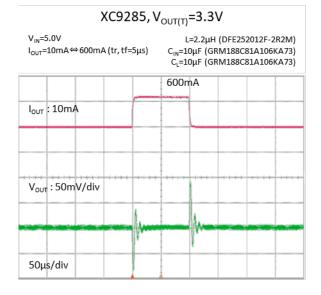
(21) Load Transient Response

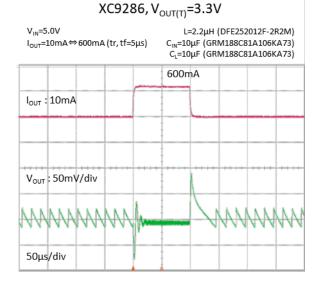






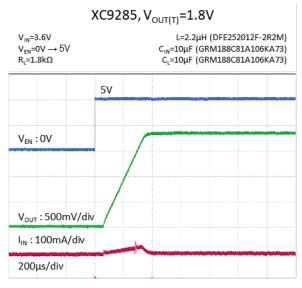


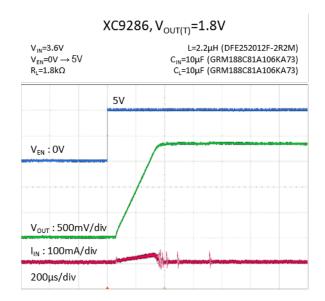




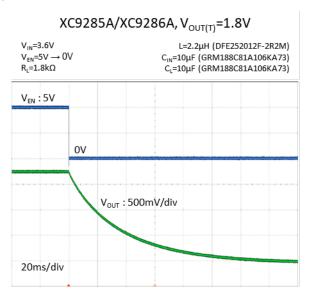
■TYPICAL PERFORMANCE CHARACTERISTICS

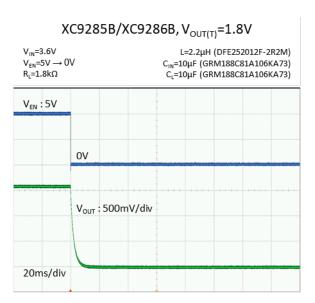
(22) Start-up





(23) Shutdown





■PACKAGE INFORMATION

For the latest package information go to, www.torexsemi.com/technical-support/packages

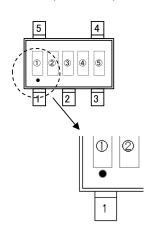
PACKAGE	OUTLINE / LAND PATTERN	THERMAL CHARACTERISTICS
SOT-25	SOT-25 PKG	SOT-25 Power Dissipation
USP-6C	USP-6C PKG	USP-6C Power Dissipation

■MARKING RULE

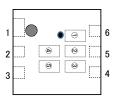
1 represents products series

MARK	PRODUCT SERIES
Р	XC9285*****-G
R	XC9286*****-G

SOT-25(Under dot)



USP-6C(Under dot)



2 represents type, Oscillation Frequency and integer part of the output voltage

MARK	Туре	VOUT (V)	fosc (Hz)	PRODUCT SERIES
Α	A	0.x	1.2M	XC9285/86A0*C**-G
В		1.x		XC9285/86A1*C**-G
С		2.x		XC9285/86A2*C**-G
D		3.x		XC9285/86A3*C**-G
E	В	0.x		XC9285/86B0*C**-G
F		1.x		XC9285/86B1*C**-G
Н		2.x		XC9285/86B2*C**-G
K		3.x		XC9285/86B3*C**-G

③ represents the decimal point of the output voltage output voltage

VOUT (V)	MARK	PRODUCT SERIES	VOUT (V)	MARK	PRODUCT SERIES
X.0	0	XC9285/86**0***-G	X.05	Α	XC9285/86**A***-G
X.1	1	XC9285/86**1***-G	X.15	В	XC9285/86**B***-G
X.2	2	XC9285/86**2***-G	X.25	С	XC9285/86**C***-G
X.3	3	XC9285/86**3***-G	X.35	D	XC9285/86**D***-G
X.4	4	XC9285/86**4***-G	X.45	Е	XC9285/86**E***-G
X.5	5	XC9285/86**5***-G	X.55	F	XC9285/86**F***-G
X.6	6	XC9285/86**6***-G	X.65	Η	XC9285/86**H***-G
X.7	7	XC9285/86**7***-G	X.75	K	XC9285/86**K***-G
X.8	8	XC9285/86**8***-G	X.85		XC9285/86**L***-G
X.9	9	XC9285/86**9***-G	X.95	М	XC9285/86**M***-G

46 represents production lot number

01 ~ 09, 0A ~ 0Z, 11 ~ 9Z, A1 ~ A9, AA ~ AZ, B1 ~ ZZ in order. (G, I, J, O, Q, W excluded)

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